## **OPE5585**

The OPE5585 is GaAlAs infrared emitting diode that is designed for high power, low forward voltage and high speed rise / fall time.

This device is optimized for speed and efficiency at emission wavelength 850nm and has a high radiant efficiency over a wide range of forward current. This device is packaged T1-3/4 plastic package and has narrow beam angle with lensed package and cup frame. Especially this device is suited as the emitter of data transmission without cable.

#### **FEATURES**

- High speed: 25ns rise time
- 850nm wavelength
- Narrow beam angle
- Low forward voltage
- High power and high reliability
- Available for pulse operating

#### **APPLICATIONS**

- Emitter of IrDA
- IR Audio and Telephone
- High speed IR communication
- IR LANs
- Available for wireless digital data transmission

### **STORAGE**

- Condition : 5°C~35°C,R.H.60%
- Terms: within 3 months from production date
- Remark: Once the package is opened, the products should be used within a day. Otherwise, it should be keeping in a damp proof box with desiccants.
- \* Please take proper steps in order to secure reliability and safety in required conditions and environments for this device.

DIMENSIONS (Unit: mm)

2-□0.5 → 4.0 Miii	
① Anode ② Cathode Tolerance : ±0.2mm	

#### MAXIMUM RATINGS

MAXIMUM RATINGS			(Ta=25°C)
Item	Symbol	Rating	Unit
Power Dissipation	$P_{\mathrm{D}}$	150	mW
Forward current	$I_{\mathrm{F}}$	100	mA
Pulse forward current *1	$I_{FP}$	1.0	A
Reverse voltage	$V_R$	4.0	V
Operating temp.	Topr.	-25~ +85	°C
Soldering terms *2	Tcol	260	°C

Soldering temp. \*2 Tsol.

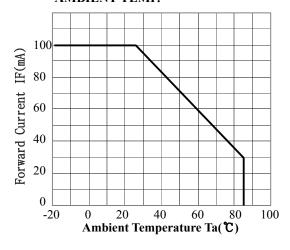
Duty ratio = 1/100, pulse width=0.1ms.

ELECTRO-OPTICAL CHARACTERISTICS (Ta=25)						
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward voltage	$V_{\mathrm{F}}$	$I_F$ =50mA		1.5	2.0	V
Reverse current	$I_R$	$V_R=4V$			10	μA
Capacitance	Ct	f=1MHz		20		pF
Radiant intensity	Ie	$I_F$ =50mA	40	100		mW/sr
Peak emission wavelength	$\lambda_p$	$I_F$ =50mA		850		nm
Spectral bandwidth 50%	Δλ	$I_F$ =50mA		45		nm
Half angle	ΔΘ	$I_F$ =50mA		±10		deg.
Optical rise & fall time(10%~90%)	tr/tf	$I_F = 50 \text{mA}$		25/13		ns
Cut off frequency *3	fc	I <sub>F</sub> =50mA DC +10mA p-p		14		MHz

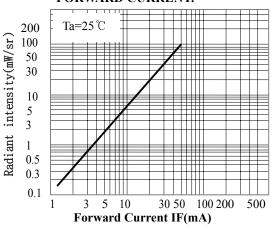
<sup>\*3. 10</sup>logPo(fc MHz)/Po(0.1 MHz)=-3

<sup>\*2.</sup>Lead Soldering Temperature (2mm from case for 5sec.).

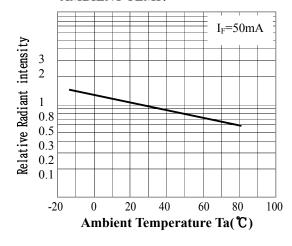
# • FORWARD CURRENT Vs. AMBIENT TEMP.



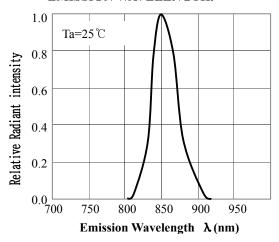
## • RADIANT INTENSITY Vs. FORWARD CURRENT.



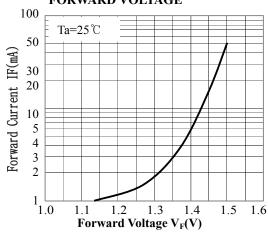
## • RELATIVE RADIANT INTENSITY Vs. AMBIENT TEMP.



## • RELATIVE RADIANT INTENSITY Vs. EMISSION WAVELENGTH.



## • FORWARD CURRENT Vs. FORWARD VOLTAGE



#### • ANGULAR DISPLACEMENT VS RELATIVE RADIANT INTENSITY

